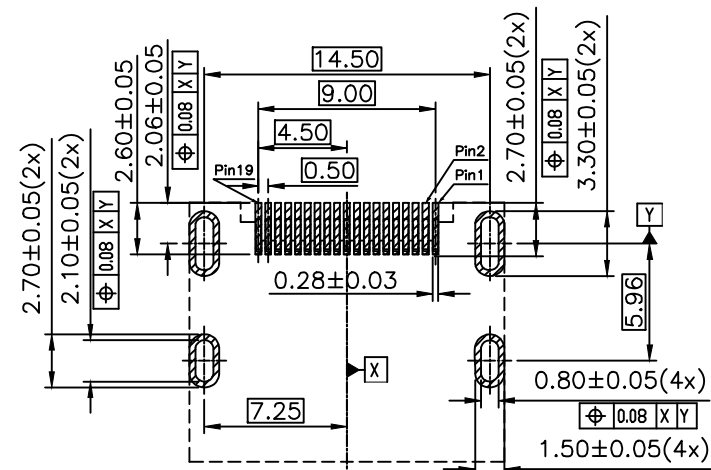
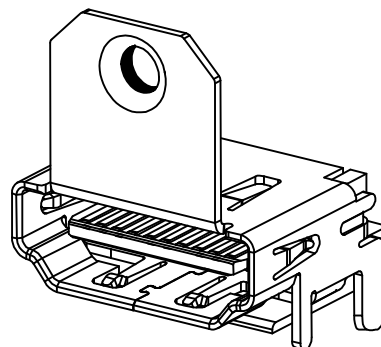
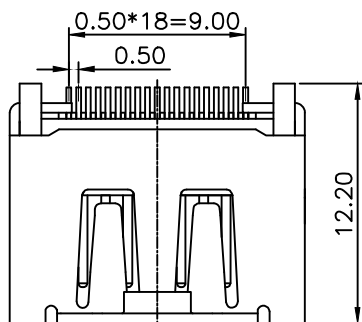
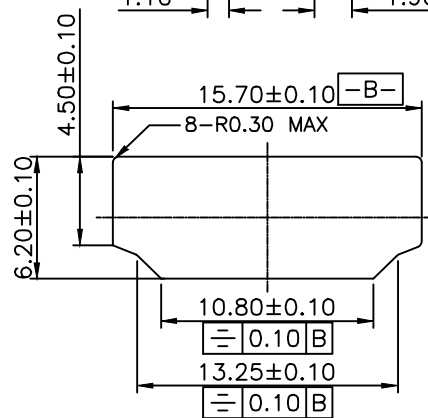
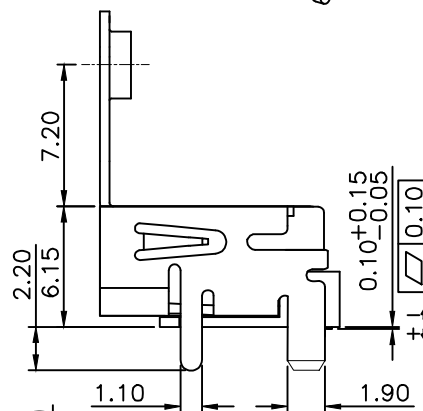
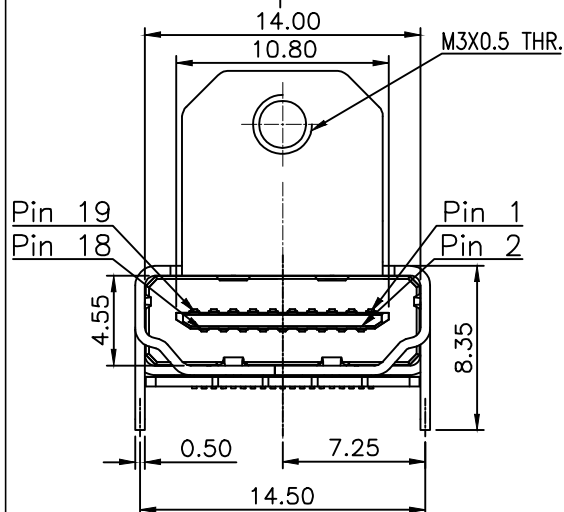


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2012/11/22	Jamie Zie
A1			Remove the bump	2012/12/04	Jamie Zie



RECOMMENDED P.C.BOARD LAYOUT (TOP VIEW) PAD AREA
TOLERANCES UNLESS OTHERWISE SPEC.±0.05 KEEP OUT ARE-



RECOMMENDED PANNEL CUT OUT DIMENSION

NOTE:

1.MATERIAL:

HOUSING:HIGH TEMPERATURE POLYESTER & LCP+GLASS FIBER UL94V-0
BLACK COLOR

ONTACT:COPPER ALLOY

SHELL:COPPER ALLOY

Finish:

CONTACT: Au PLATING ON CONTACT AREA

SOLDERING AREA: 100u" MIN. TIN PLATING ON SOLDER TAILS

SHELL: 80u" MIN NICKEL PLATING

NO	VARIETY	QTY	METERIAL	REMARK
Matrix Electronics Co.,Ltd				
TOLERANCE:		DESIGN BY :	DATE :	PART NAME:
X:X ±0.38		Jamie Zie	2012/12/04	HDMI SMD 19 PIN
X:XX ±0.25		CHECKED BY:	DATE :	PART NO.
X:XXX ±0.13		Vilen Lee	2012/12/04	MHDF-B1901-022-RS
ANGLE: ±3°		APPROVED BY1:	DATE :	MOLD NO.
		Richard Hsieh	2012/12/04	NA
UNIT: mm [inch]		APPROVED BY2:	DATE :	DRAW NO.
SCALE:1:1		Richard Hsieh	2012/12/04	SHEET NO.
SIZE:A4				1 OF 1